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CLAIMS: Please amend the claims according to the status designations in the following list, which contains all claims that were ever in the patent application, with the text of all active claims.

What I claim are:

- 1. (Currently amended) A semiconductor device, comprising
 a substante with texture on the top surface of said substante, and
 an epitaxial layer comprising an active layer and grown on the top of said texture.
- (Original) The aemiconductor device of claim 1, further comparising buller layer grown
 in between said spitaxial layer and said texture.
- (Original) The semiconductor device of claim 1, wherein said texture comprising wells and walls.
- (Original) The comiconductor device of claim 3, wherein the width of said walls is in a range of nanometers to micrometers.
- (Original) The semiconductor device of claim 3, wherein the depth of suid well is in a range of nanometers to micrometers.
- (Contently amended)The semiconductor device of claim 3, wherein said wells having a shape of rectangular.
- (Original) The semiconductor device of claim 6, wherein the dimension of said wells is in the range of nanometers to micrometers.
- (currently annualral) The semiconductor device of olum 1, wherein said epitaxial layer of said semiconductor device entits light.
- 9. [Deletion] A semiconductor device, comprising

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- a substrate with first texture on one of its two surfaces,
- a first epitasual layer comprising first active layer and grown on the top of said first texture.
- a second texture etched on the top surface of said first epirockal layer,
- a second epitaxial layer comprising second active layer and grown on the top of said second texture.
- 10. [Deletion] The semiconductor device of claim 9, further comprising first buffer layer grown in between said first epitoxial layer and said first texture of said substrate, and a second buffer layer grown in between and second epitoxial layer and said second texture of said first epitoxial layer.
- [Deletion] The semiconductor device of claim 9, wherein both said first texture and said second texture comprising wells and walls.
- [Deletion] The semiconductor device of claim 11, wherein the width of said walls is in a
 range of nanometers to micrometers.
- 13. [Deletion]The semiconductor device of claim 11, wherein the depth of said wells is in a range of manumeters to micrometers.
- [Deletion] The semiconductor device of claim 11, wherein and wells have the shape of said semiconductor device.
- 15. [Deletion]The semicanuluctor device of claim 11, wherein the dimension of said wells is in the range of nanometers to micrometers.
- 16. [Deletion] The semiconductor device of claim 9, wherein said substrate emits light.